

MOSFET

OptiMOS[™] 5 Power-Transistor, 80 V

Features

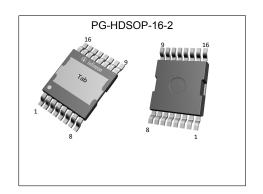
- Optimized for motor drives and battery powered applications
- Optimized for top side coolingHigh current capability
- 175°C rated
- 100% avalanche tested
- Superior thermal performance
- N-channel
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

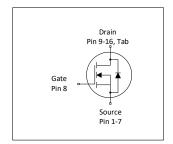


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	80	V
R _{DS(on),max}	1.2	mΩ
I _D	396	A
Qoss	204	nC
Q _G	175	nC











Type / Ordering Code	Package	Marking	Related Links
IPTC012N08NM5	PG-HDSOP-16	12N08NM5	-

OptiMOS[™] 5 Power-Transistor, 80 V



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OptiMOS[™] 5 Power-Transistor, 80 V IPTC012N08NM5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Doromotor	C. mahal		Value	s		N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - - -	- - - -	396 283 231 40	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =6 V, T_{C} =100 °C V_{GS} =10 V, T_{A} =25 °C, R_{thJA} =40 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1584	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	817	mJ	I_D =150 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	375 3.8	W	T _C =25 °C T _A =25 °C, R _{thJA} =40 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Farameter	Syllibol	Min.	Тур.	Max.	Offic	Note / Test Condition
Thermal resistance, junction - case, Top	R _{thJC}	-	-	0.4	°C/W	-
Thermal characterization parameter, junction to lead (Pin 1-7) ⁵⁾	Ψ_{JL}	-	9	-	°C/W	-
Thermal characterization parameter, junction to lead (Pin 9-16) ⁵⁾	Ψ_{JL}	-	3	-	°C/W	-
Thermal resistance, junction - ambient	R _{thJA}	-	40	-	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

⁵⁾ Ψ_{JL} is a temperature characterization parameter according to JESD51-12 referring to the temperature difference between junction and leads in the case of natural convection. It can be used to estimate the component junction temperature in the application by measuring the temperature at the leads in the stated application environment

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	0	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.2	3	3.8	V	V _{DS} =V _{GS} , I _D =275 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	1.0 1.4	1.2 1.8	mΩ	V _{GS} =10 V, I _D =100 A V _{GS} =6 V, I _D =75 A
Gate resistance	R _G	-	1.5	-	Ω	-
Transconductance	g fs	-	250	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 100 A$

Table 5 **Dynamic characteristics**

Dougnatou	Consolo a l		Values			N 4 7 4 2 100
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	12000	16000	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	2000	2600	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	85	150	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Turn-on delay time	$t_{ m d(on)}$	-	31	_	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =3.5 Ω
Rise time	t _r	-	19	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =3.5 Ω
Turn-off delay time	$t_{ m d(off)}$	-	69	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =3.5 Ω
Fall time	t _f	-	55	_	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =3.5 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Cumbal	Values			11:4	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	55	-	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	37	-	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q_{gd}	-	37	56	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V
Switching charge	Q _{sw}	-	55	-	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Q g	-	175	219	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.5	-	V	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	204	271	nC	V _{DS} =40 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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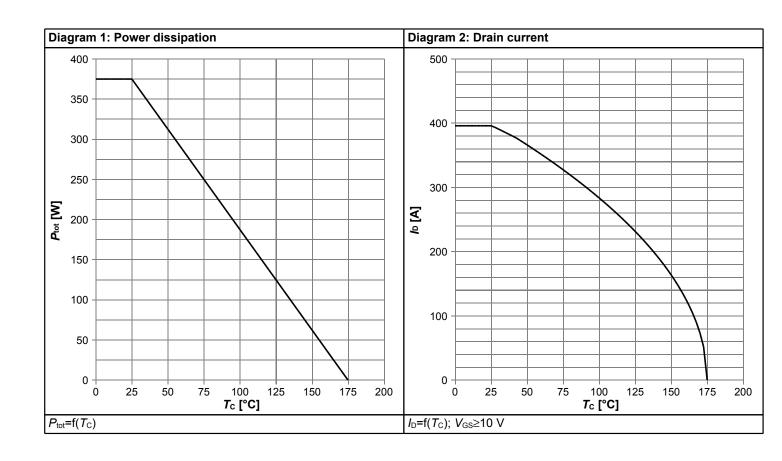


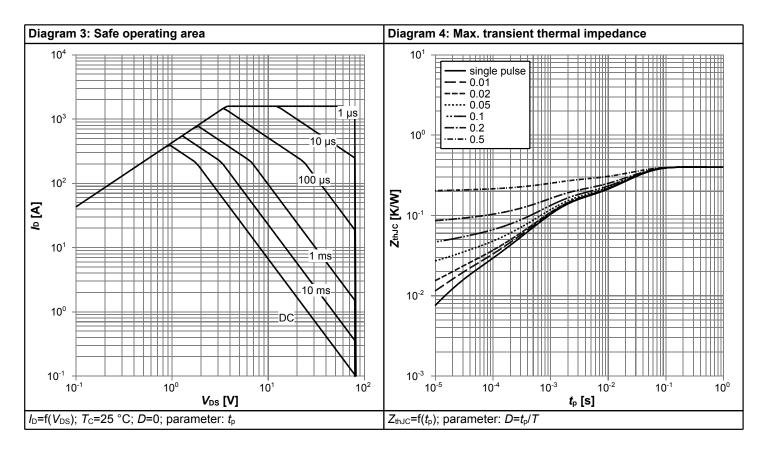
Table 7 Reverse diode

Parameter	Symbol		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	I _S	-	-	300	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1584	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.85	1	V	V _{GS} =0 V, I _F =100 A, T _j =25 °C
Reverse recovery time	t _{rr}	-	86	-	ns	V _R =40 V, I _F =50 A, di _F /dt=100 A/μs
Reverse recovery charge	Qrr	-	177	-	nC	V_R =40 V, I_F =50 A, di_F/dt =100 A/ μ s

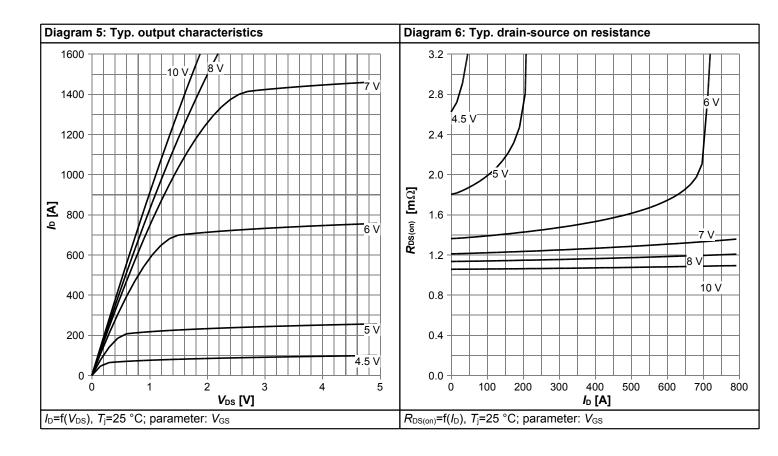


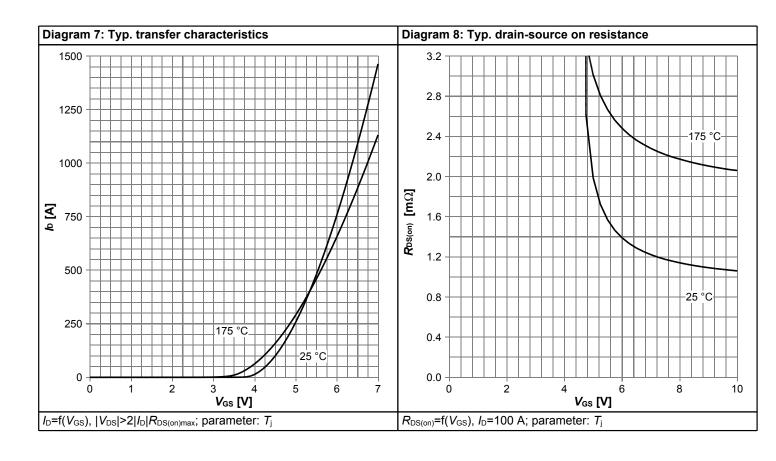
4 Electrical characteristics diagrams



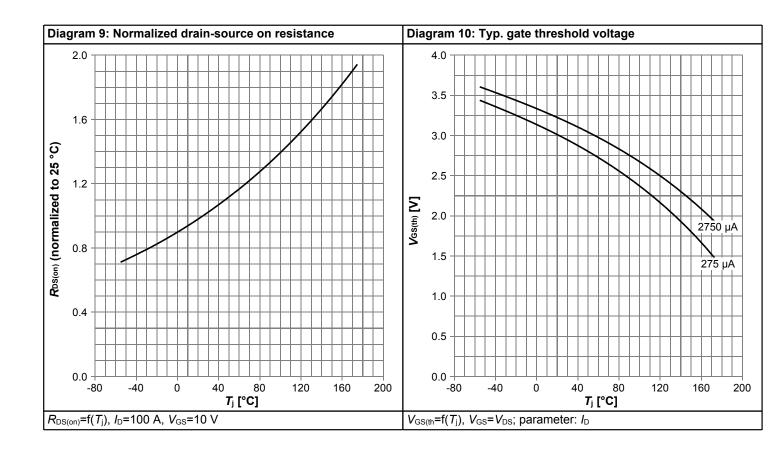


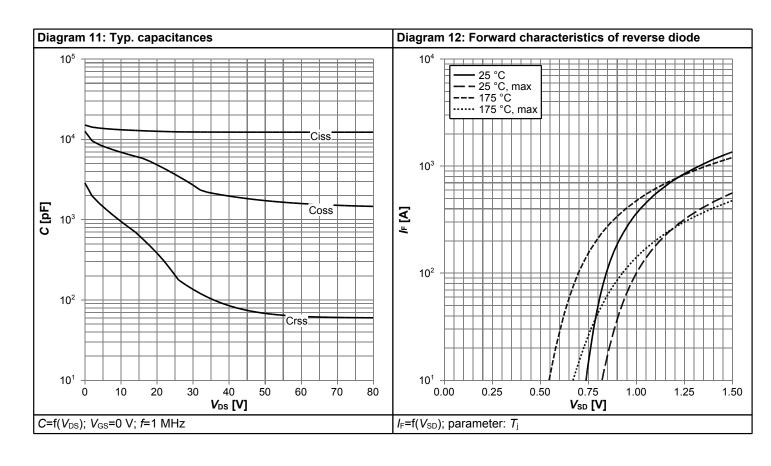




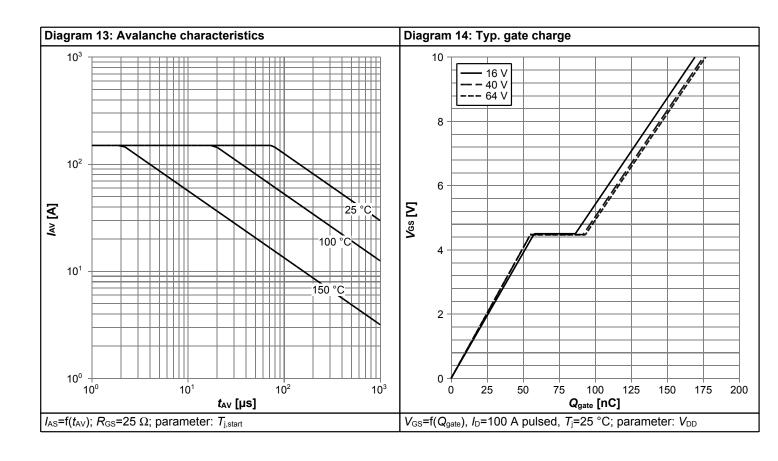


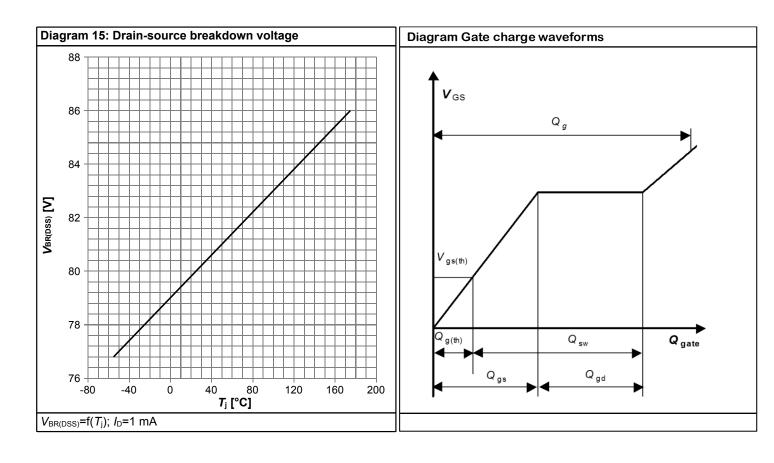






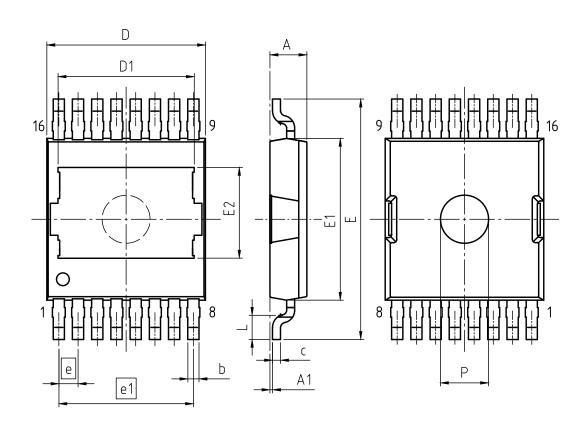








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-HDSOP-16-U01						
REVISION: 01	DATE:	DATE: 18.12.2020					
DIMENSIONS	MILLIM	ETERS					
DIMENSIONS	MIN.	MAX.					
Α	2.25	2.35					
A1	0.01	0.16					
b	0.60	0.80					
С	0.40	0.60					
D	9.70	10.10					
D1	8.20	8.40					
E	14.80	15.20					
E1	10.00	10.30					
E2	5.57	5.77					
е	1.20						
e1	8.	40					
L	1.40	1.60					
Р	2.90	3.10					

Figure 1 Outline PG-HDSOP-16, dimensions in mm

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Revision History

IPTC012N08NM5

Revision: 2021-02-02, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2021-02-02	Release of final version

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Final Data Sheet 11 Rev. 2.0, 2021-02-02